

32K x 9 Static RAM

Features

- **High speed**
— 15 ns
- **Automatic power-down when deselected**
- **Low active power**
— 660 mW
- **Low standby power**
— 140 mW
- **CMOS for optimum speed/power**
- **TTL-compatible inputs and outputs**
- **Easy memory expansion with \overline{CE}_1 , CE_2 , and \overline{OE} features**

Functional Description

The CY7C188 is a high-performance CMOS static RAM organized as 32,768 words by 9 bits. Easy memory expansion is provided by an active-LOW chip enable (\overline{CE}_1), an active-HIGH chip enable (CE_2), an active-LOW output enable (\overline{OE}), and three-state drivers. The device has an automatic power-down feature that reduces power consumption by more than 75% when deselected.

Writing to the device is accomplished by taking \overline{CE}_1 and write enable (\overline{WE}) inputs LOW and CE_2 input HIGH. Data on the nine I/O pins ($I/O_0 - I/O_8$) is then written

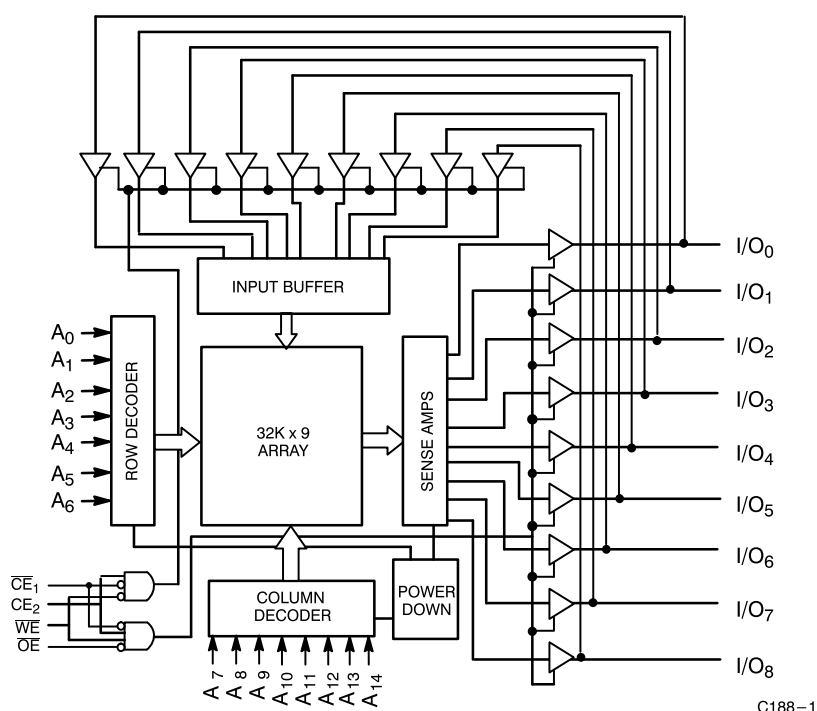
into the location specified on the address pins ($A_0 - A_{14}$).

Reading from the device is accomplished by taking \overline{CE}_1 and \overline{OE} LOW while forcing \overline{WE} and CE_2 HIGH. Under these conditions, the contents of the memory location specified by the address pins will appear on the I/O pins.

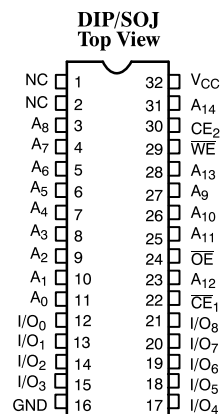
The nine input/output pins ($I/O_0 - I/O_8$) are placed in a high-impedance state when the device is deselected (\overline{CE}_1 HIGH or CE_2 LOW), the outputs are disabled (\overline{OE} HIGH), or during a write operation (\overline{CE}_1 LOW, CE_2 HIGH, and \overline{WE} LOW).

The CY7C188 is available in standard 300-mil-wide SOJs.

Logic Block Diagram



Pin Configuration



C188-2

C188-1

Selection Guide

		7C188-15	7C188-20	7C188-25	7C188-35
Maximum Access Time (ns)		15	20	25	35
Maximum Operating Current (mA)	Commercial	120	170	165	160
Maximum Standby Current (mA)		35	35	35	30

Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature -65°C to $+150^{\circ}\text{C}$
 Ambient Temperature with
 Power Applied -55°C to $+125^{\circ}\text{C}$
 Supply Voltage on V_{CC} Relative to GND
 (Pin 32 to Pin 16) -0.5V to $+7.0\text{V}$
 DC Voltage Applied to Outputs
 in High Z State^[1] -0.5V to $V_{CC} + 0.5\text{V}$
 DC Input Voltage^[1] -0.5V to $V_{CC} + 0.5\text{V}$

Output Current into Outputs (LOW) 20 mA

Static Discharge Voltage $>2001\text{V}$
 (per MIL-STD-883, Method 3015)

Latch-Up Current $>200\text{ mA}$

Operating Range

Range	Ambient Temperature	V_{CC}
Commercial	0°C to $+70^{\circ}\text{C}$	$5\text{V} \pm 10\%$

Electrical Characteristics Over the Operating Range^[2]

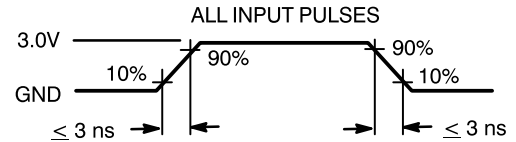
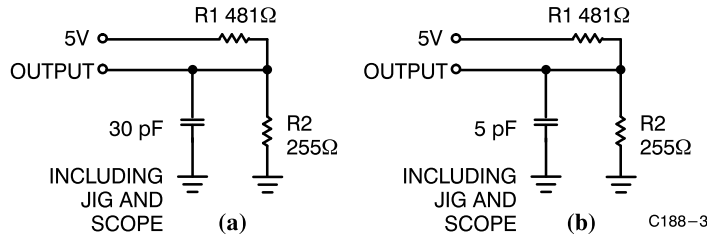
Parameter	Description	Test Conditions	7C188-15		7C188-20		7C188-25		7C188-35		Unit
			Min	Max	Min.	Max.	Min.	Max.	Min.	Max.	
V_{OH}	Output HIGH Voltage	$V_{CC} = \text{Min.}, I_{OH} = -4.0\text{ mA}$	2.4		2.4		2.4		2.4		V
V_{OL}	Output LOW Voltage	$V_{CC} = \text{Min.}, I_{OL} = 8.0\text{ mA}$		0.4		0.4		0.4		0.4	V
V_{IH}	Input HIGH Voltage		2.2	$V_{CC} + 0.3$	2.2	$V_{CC} + 0.3$	2.2	$V_{CC} + 0.3$	2.2	$V_{CC} + 0.3$	V
V_{IL}	Input LOW Voltage ^[1]		-0.5	0.8	-0.5	0.8	-0.5	0.8	-0.5	0.8	V
I_{IX}	Input Load Current	$\text{GND} \leq V_I \leq V_{CC}$	-5	+5	-5	+5	-5	+5	-5	+5	μA
I_{OZ}	Output Leakage Current	$\text{GND} \leq V_I \leq V_{CC},$ Output Disabled	-5	+5	-5	+5	-5	+5	-5	+5	μA
I_{OS}	Output Short Circuit Current ^[3]	$V_{CC} = \text{Max.}, V_{OUT} = \text{GND}$		-300		-300		-300		-300	mA
I_{CC}	V_{CC} Operating Supply Current	$V_{CC} = \text{Max.}, I_{OUT} = 0\text{ mA},$ $f = f_{\text{MAX}} = 1/t_{\text{RC}}$		120		170		165		160	mA
I_{SB1}	Automatic CE Power-Down Current—TTL Inputs	Max. $V_{CC}, \overline{\text{CE}}_1 \geq V_{IH}$ or $\text{CE}_2 \leq V_{IL},$ $V_{IN} \geq V_{IH}$ or $V_{IN} \leq V_{IL},$ $f = f_{\text{MAX}}$		35		35		35		30	mA
I_{SB2}	Automatic CE Power-Down Current—CMOS Inputs	Max. $V_{CC}, \overline{\text{CE}}_1 \geq V_{CC} - 0.3\text{V}$ or $\text{CE}_2 \leq 0.3\text{V},$ $V_{IN} \geq V_{CC} - 0.3\text{V}$ or $V_{IN} \leq 0.3\text{V}, f = 0$		10		15		15		15	mA

Capacitance^[4]

Parameter	Description	Test Conditions	Max.	Unit
C_{IN} : Addresses	Input Capacitance	$T_A = 25^{\circ}\text{C}, f = 1\text{ MHz},$ $V_{CC} = 5.0\text{V}$	6	pF
C_{IN} : Controls			8	pF
C_{OUT}	Output Capacitance		8	pF

Notes:

- Minimum voltage is equal to -2.0V for pulse durations less than 20 ns.
- See the last page of this specification for Group A subgroup testing information.
- Not more than one output should be shorted at one time. Duration of the short circuit should not exceed 30 seconds.
- Tested initially and after any design or process changes that may affect these parameters.

AC Test Loads and Waveforms^[5, 6]


C188-4

Equivalent to: THÉVENIN EQUIVALENT

167Ω

OUTPUT ——— 1.73V

Switching Characteristics Over the Operating Range^[2, 5]

Parameter	Description	7C188-15		7C188-20		7C188-25		7C188-35		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
READ CYCLE										
t _{RC}	Read Cycle Time	15		20		25		35		ns
t _{AA}	Address to Data Valid		15		20		25		35	ns
t _{OHA}	Data Hold from Address Change	3		3		3		3		ns
t _{ACE}	\overline{CE}_1 LOW or CE ₂ HIGH to Data Valid		15		20		25		35	ns
t _{DOE}	\overline{OE} LOW to Data Valid		7		9		10		16	ns
t _{LZOE}	\overline{OE} LOW to Low Z ^[7]	0		0		3		3		ns
t _{HZOE}	\overline{OE} HIGH to High Z ^[6, 7]		7		9		11		15	ns
t _{LZCE}	\overline{CE}_1 LOW or CE ₂ HIGH to Low Z ^[7]	3		3		3		3		ns
t _{HZCE}	\overline{CE}_1 HIGH or CE ₂ LOW to High Z ^[6, 7]		7		9		11		15	ns
t _{PU}	\overline{CE}_1 LOW or CE ₂ HIGH to Power-Up	0		0		0		0		ns
t _{PD}	\overline{CE}_1 HIGH or CE ₂ LOW to Power-Down		15		20		20		20	ns
WRITE CYCLE ^[8, 9]										
t _{WC}	Write Cycle Time	15		20		25		35		ns
t _{SCE}	\overline{CE}_1 LOW or CE ₂ HIGH to Write End	10		15		18		22		ns
t _{AW}	Address Set-Up to Write End	10		15		20		30		ns
t _{HA}	Address Hold from Write End	0		0		0		0		ns
t _{SA}	Address Set-Up to Write Start	0		0		0		0		ns
t _{PWE}	\overline{WE} Pulse Width	10		15		18		22		ns
t _{SD}	Data Set-Up to Write End	8		10		10		15		ns
t _{HD}	Data Hold from Write End	0		0		0		0		ns
t _{HZWE}	\overline{WE} LOW to High Z ^[6]	0	7	0	7	0	11	0	15	ns
t _{LZWE}	\overline{WE} HIGH to Low Z ^[6, 7]	3		3		3		3		ns

Notes:

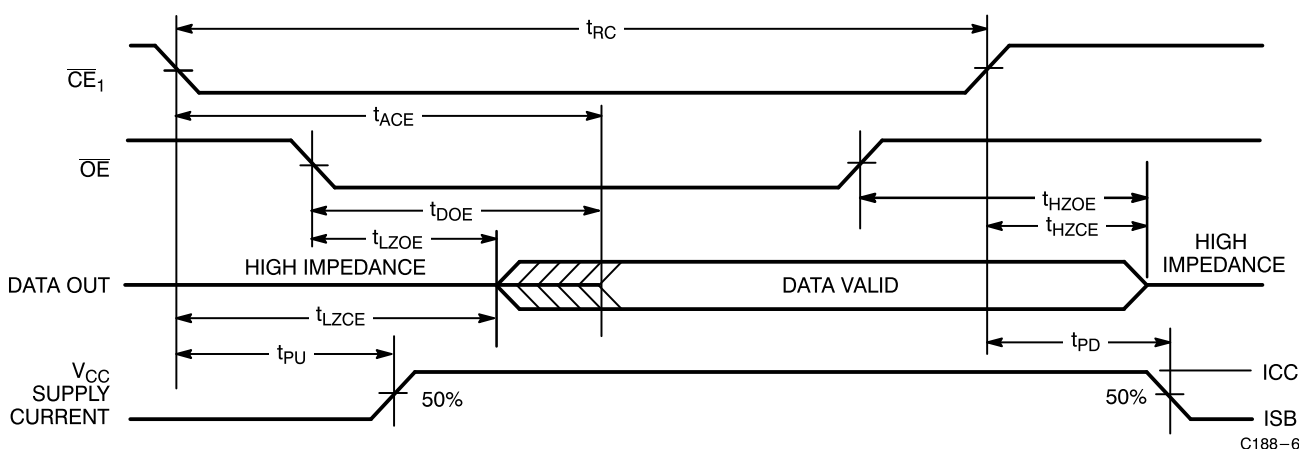
- Test conditions assume signal transition time of 3 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V, and output loading of the specified I_{OL}/I_{OH} and 30-pF load capacitance.
- t_{HZOE}, t_{HZCE}, and t_{HZWE} are specified with C_L = 5 pF as in part (b) of AC Test Loads. Transition is measured ±500 mV from steady-state voltage.
- At any given temperature and voltage condition, t_{HZCE} is less than t_{LZCE}, t_{HZOE} is less than t_{LZOE}, and t_{HZWE} is less than t_{LZWE} for any given device.
- The internal write time of the memory is defined by the overlap of \overline{CE}_1 , LOW, CE₂ HIGH, and \overline{WE} LOW. All three signals must be asserted to initiate a write and any signal can terminate a write by being deasserted. The data input set-up and hold timing should be referenced to the rising edge of the signal that terminates the write.
- The minimum write cycle time for write cycle #3 (\overline{WE} controlled, \overline{OE} LOW) is the sum of t_{HZWE} and t_{SD}.



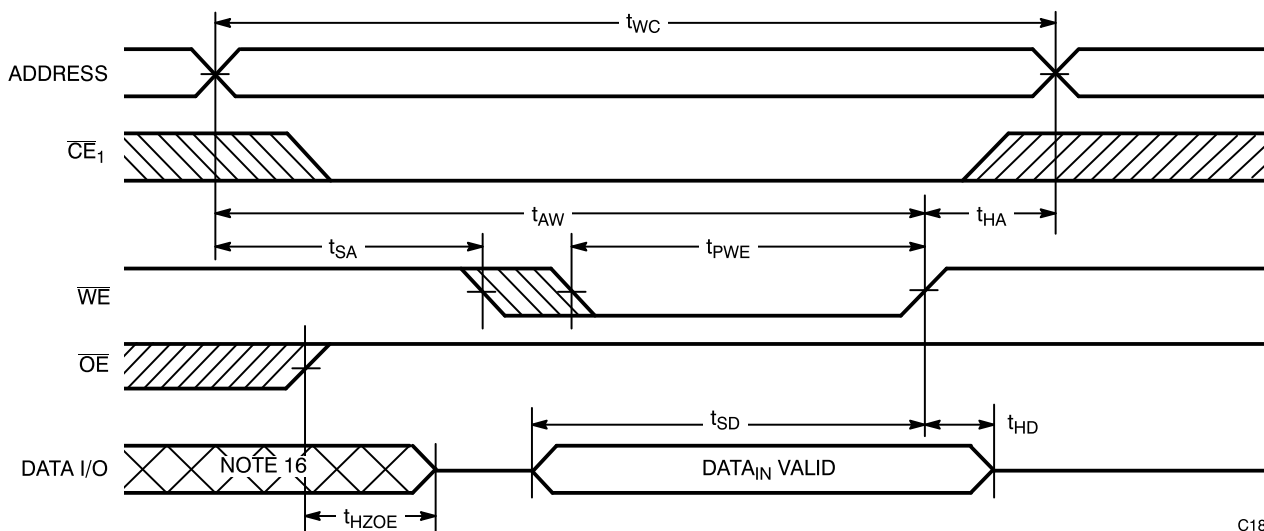
Read Cycle No. 1^[10, 11]



Read Cycle No. 2 (Chip-Enable Controlled)^[11, 12, 13]

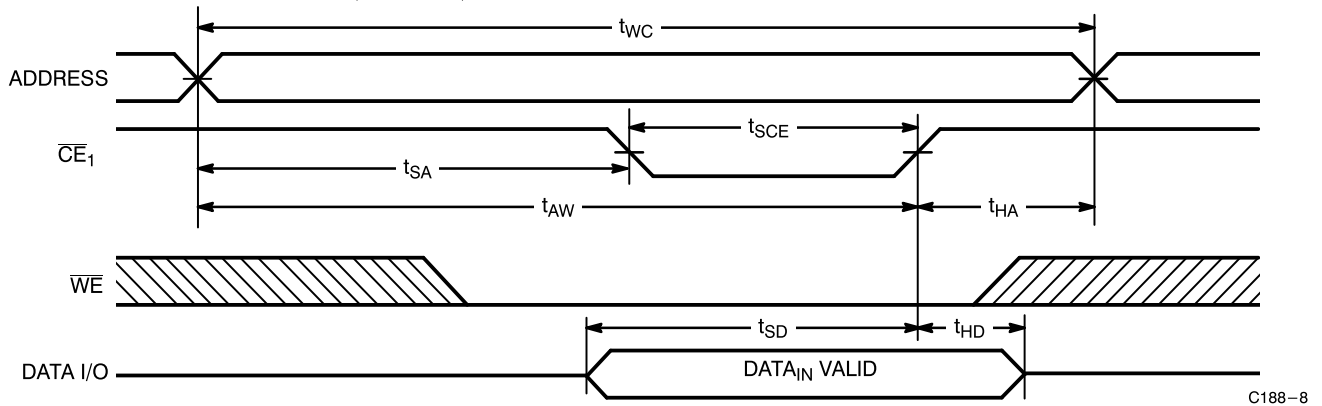
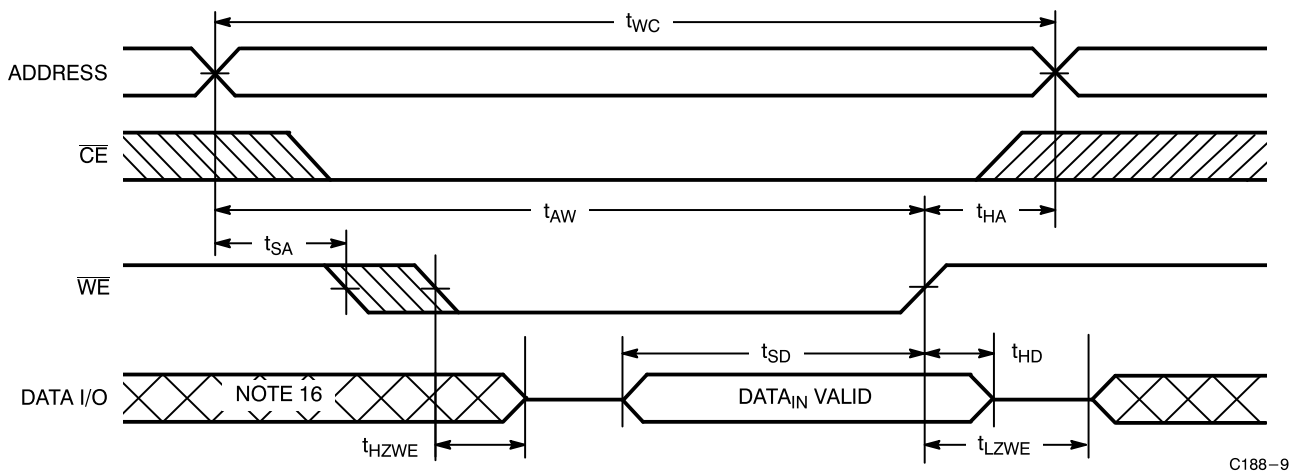


Write Cycle No. 1 ($\overline{\text{WE}}$ Controlled)[8, 13, 14, 15]



Notes:

10. Device is continuously selected. $\overline{OE}, \overline{CE} = V_{IL}$.
11. \overline{WE} is HIGH for read cycle.
12. Address valid prior to or coincident with \overline{CE} transition LOW.
13. Timing parameters are the same for all chip enable signals (\overline{CE}_1 and \overline{CE}_2), so only the timing for \overline{CE}_1 is shown.
14. Data I/O is high impedance if $\overline{OE} = V_{IH}$.
15. If \overline{CE} goes HIGH simultaneously with \overline{WE} HIGH, the output remains in a high-impedance state.
16. During this period, the I/Os are in the output state and input signals should not be applied.

Switching Waveforms (continued)
Write Cycle No. 2 (\overline{CE} Controlled) (continued) [8, 13, 14, 15]

Write Cycle No. 3 (\overline{WE} Controlled, \overline{OE} LOW) [9, 13, 15]


Truth Table

\overline{CE}	\overline{WE}	\overline{OE}	Input/Output	Mode	Power
H	X	X	High Z	Deselect/Power-Down	Standby (I_{SB})
L	H	L	Data Out	Read	Active (I_{CC})
L	L	X	Data In	Write	Active (I_{CC})
L	H	H	High Z	Deselect, Output Disabled	Active (I_{CC})

Ordering Information

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
15	CY7C188-15VC	V32	32-Lead (300-Mil) Molded SOJ	Commercial
20	CY7C188-20VC	V32	32-Lead (300-Mil) Molded SOJ	
25	CY7C188-25VC	V32	32-Lead (300-Mil) Molded SOJ	
35	CY7C188-35VC	V32	32-Lead (300-Mil) Molded SOJ	

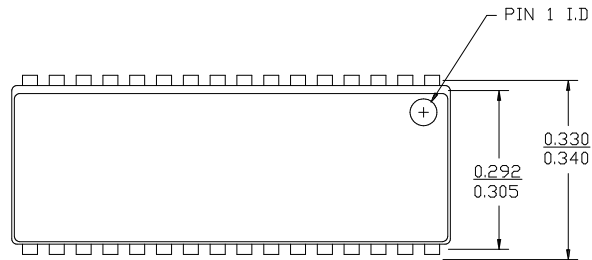
MILITARY SPECIFICATIONS
Group A Subgroup Testing
DC Characteristics

Parameter	Subgroups
V_{OH}	1, 2, 3
V_{OL}	1, 2, 3
V_{IH}	1, 2, 3
V_{IL} Max.	1, 2, 3
I_{IX}	1, 2, 3
I_{OZ}	1, 2, 3
I_{CC}	1, 2, 3
I_{SB1}	1, 2, 3
I_{SB2}	1, 2, 3

Switching Characteristics

Parameter	Subgroups
READ CYCLE	
t_{RC}	7, 8, 9, 10, 11
t_{AA}	7, 8, 9, 10, 11
t_{OHA}	7, 8, 9, 10, 11
t_{ACE}	7, 8, 9, 10, 11
t_{DOE}	7, 8, 9, 10, 11
WRITE CYCLE	
t_{WC}	7, 8, 9, 10, 11
t_{SCE}	7, 8, 9, 10, 11
t_{AW}	7, 8, 9, 10, 11
t_{HA}	7, 8, 9, 10, 11
t_{SA}	7, 8, 9, 10, 11
t_{PWE}	7, 8, 9, 10, 11
t_{SD}	7, 8, 9, 10, 11
t_{HD}	7, 8, 9, 10, 11

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Package Diagrams
32-Lead (300-Mil) Molded SOJ V32


DIMENSIONS IN INCHES MIN.
MAX.

